

## Automotive Grade, Galvanically Isolated Current Sensor IC With Common Mode Field Rejection in a Small Footprint SOIC8 Package

### FEATURES AND BENEFITS

- · Differential Hall sensing rejects common mode fields
- $1.2 \text{ m}\Omega$  primary conductor resistance for low power loss and high inrush current withstand capability
- Integrated shield virtually eliminates capacitive coupling from current conductor to die, greatly suppressing output noise due to high dv/dt transients
- Industry-leading noise performance with greatly improved bandwidth through proprietary amplifier and filter design techniques
- High bandwidth 120KHz analog output for faster response times in control applications.
- Filter pin allows user to filter the output for improved resolution at lower bandwidth.
- Patented integrated digital temperature compensation circuitry allows for near closed loop accuracy over temperature in an open loop sensor
- Small footprint, low-profile SOIC8 package suitable for space-constrained applications
- Filter pin simplifies bandwidth limiting for better resolution at lower frequencies

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## Package: 8-Pin SOIC (suffix LC)





Approximate Scale 1:1

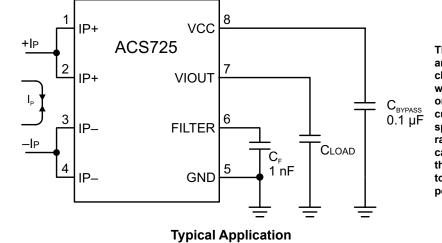
### DESCRIPTION

The Allegro<sup>™</sup> ACS725 current sensor IC is an economical and precise solution for AC or DC current sensing in industrial, automotive, commercial, and communications systems. The small package is ideal for space constrained applications while also saving costs due to reduced board area. Typical applications include motor control, load detection and management, switched-mode power supplies, and overcurrent fault protection.

The device consists of a precise, low-offset, linear Hall sensor circuit with a copper conduction path located near the surface of the die. Applied current flowing through this copper conduction path generates a magnetic field which is sensed by the integrated Hall IC and converted into a proportional voltage. The current is sensed differentially in order to reject common mode fields, improving accuracy in magnetically noisy environments. The inherent device accuracy is optimized through the close proximity of the magnetic field to the Hall transducer. A precise, proportional voltage is provided by the low-offset, chopper-stabilized BiCMOS Hall IC, which is programmed for accuracy after packaging. The output of the device has a positive slope when an increasing current flows through the primary copper conduction path (from pins 1 and 2, to pins 3 and 4), which is the path used for current sensing. The internal resistance of this conductive path is  $1.2 \,\mathrm{m}\Omega$  typical, providing low power loss.

The terminals of the conductive path are electrically isolated from the sensor leads (pins 5 through 8). This allows the ACS725 current sensor IC to be used in high-side current sense applications without the use of high-side differential amplifiers or other costly isolation techniques.

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The ACS725 outputs an analog signal,  $V_{IOUT}$ , that changes, proportionally, with the bidirectional AC or DC primary sensed current,  $I_P$ , within the specified measurement range. The FILTER pin can be used to decrease the bandwidth in order to optimize the noise performance.

## Features and Benefits (continued)

- 3.3 V, single supply operation
- Output voltage proportional to AC or DC current
- Factory-trimmed sensitivity and quiescent output voltage for improved accuracy
- Chopper stabilization results in extremely stable quiescent output voltage
- Nearly zero magnetic hysteresis
- Ratiometric output from supply voltage

## **Description (continued)**

The ACS725 is provided in a small, low profile surface mount SOIC8 package. The leadframe is plated with 100% matte tin, which is compatible with standard lead (Pb) free printed circuit board assembly processes. Internally, the device is Pb-free, except for flip-chip high-temperature Pb-based solder balls, currently exempt from RoHS. The device is fully calibrated prior to shipment from the factory.

#### **Selection Guide**

Part Number	I <sub>PR</sub> (A)	Sens(Typ) at V <sub>CC</sub> = 3.3 V (mV/A)	T <sub>A</sub> (°C)	Packing*
ACS725LLCTR-10AU-T	10	264		
ACS725LLCTR-20AB-T	±20	66	40 to 150	Tana and Daal 2000 piagas per real
ACS725LLCTR-30AB-T	±30	44	-40 to 150	Tape and Reel, 3000 pieces per reel
ACS725LLCTR-40AB-T	25LLCTR-40AB-T ±40 33			

\*Contact Allegro for additional packing options.



## **SPECIFICATIONS**

#### **Absolute Maximum Ratings**

Characteristic	Symbol	Notes	Rating	Units
Supply Voltage	V <sub>CC</sub>		6	V
Reverse Supply Voltage	V <sub>RCC</sub>		-0.1	V
Output Voltage	V <sub>IOUT</sub>		V <sub>CC</sub> + 0.5	V
Reverse Output Voltage	V <sub>RIOUT</sub>		-0.1	V
Operating Ambient Temperature	T <sub>A</sub>	Range L	-40 to 150	°C
Junction Temperature	T <sub>J</sub> (max)		165	°C
Storage Temperature	T <sub>stg</sub>		–65 to 165	°C

#### **Isolation Characteristics**

Characteristic	Symbol	Notes	Rating	Unit
Dielectric Strength Test Voltage	V <sub>ISO</sub>	Agency type-tested for 60 seconds per UL standard 60950-1 (edition 2). Production tested at $V_{\rm ISO}$ for 1 second, in accordance with UL 60950-1 (edition 2).	2400	V <sub>RMS</sub>
Working Voltage for Desig Isolation	N	Maximum approved working voltage for basic (single)	420	V <sub>pk</sub> or VDC
Working Voltage for Basic Isolation	V <sub>WVBI</sub>	isolation according UL 60950-1 (edition 2)	297	V <sub>rms</sub>
Clearance	D <sub>cl</sub> Minimum distance through air from IP leads to signal leads		3.9	mm
Creepage	D <sub>cr</sub>	Minimum distance along package body from IP leadds to signal leads	3.9	mm

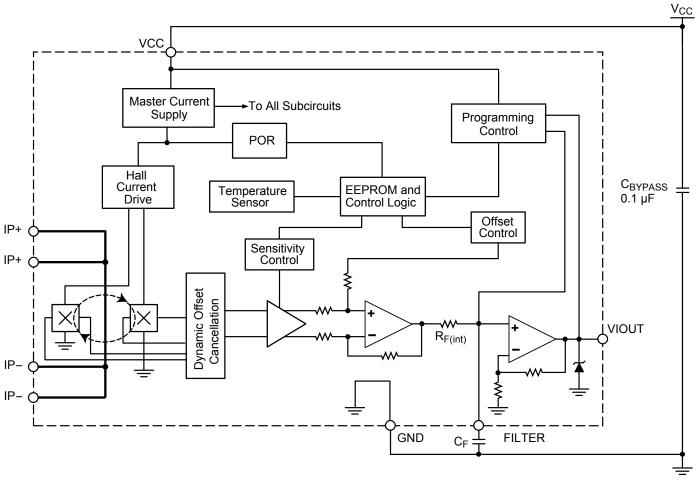
#### **Thermal Characteristics**

Characteristic	Symbol	Test Conditions*	Value	Units
Package Thermal Resistance (Junction to Ambient)	R <sub>θJA</sub>	Mounted on the Allegro 85-0140 evaluation board with 800 mm <sup>2</sup> of 4 oz. copper on each side, connected to pins 1 and 2, and to pins 3 and 4, with thermal vias connecting the layers. Performance values include the power consumed by the PCB.	23	°C/W
Package Thermal Resistance (Junction to Lead)	$R_{ extsf{ heta}JL}$	Mounted on the Allegro ASEK 725 evaluation board.	5	°C/W

\*Additional thermal information available on the Allegro website.

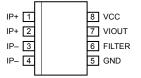


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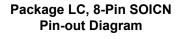
**Functional Block Diagram** 

## **Pin-out Diagram and Terminal List Table**



Terminal List Table

Number	Name	Description
1, 2	IP+	Terminals for current being sensed; fused internally
3, 4	IP-	Terminals for current being sensed; fused internally
5	GND	Signal ground terminal
6	FILTER	Terminal for external capacitor that sets bandwidth
7	VIOUT	Analog output signal
8	VCC	Device power supply terminal





#### COMMON ELECTRICAL CHARACTERISTICS<sup>1</sup>: valid through the full range of $T_A$ , $V_{CC}$ = 3.3 V, $C_F$ = 0, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Supply Voltage	V <sub>cc</sub>		3	3.3	3.6	V
Supply Current	I <sub>CC</sub>	V <sub>CC</sub> = 3.3 V, output open	-	10	14	mA
Output Capacitance Load	CL	VIOUT to GND	-	-	10	nF
Output Resistive Load	RL	VIOUT to GND	4.7	-	_	kΩ
Primary Conductor Resistance	R <sub>IP</sub>	T <sub>A</sub> = 25°C	-	1.2	_	mΩ
Internal Filter Resistance <sup>2</sup>	R <sub>F(int)</sub>		-	1.8	_	kΩ
Primary Hall Coupling Factor	G1	T <sub>A</sub> = 25°C	-	11	_	G/A
Secondary Hall Coupling Factor	G2	T <sub>A</sub> = 25°C	-	2.8	_	G/A
Hall plate Sensitivity Matching	Sens <sub>match</sub>	T <sub>A</sub> = 25°C	-	±1	_	%
Rise Time	t <sub>r</sub>	$I_{P} = I_{P}(max), T_{A} = 25^{\circ}C, C_{L} = 1 \text{ nF}$	-	3	_	μs
Propagation Delay	t <sub>pd</sub>	$I_{P} = I_{P}(max), T_{A} = 25^{\circ}C, C_{L} = 1 \text{ nF}$	-	2	_	μs
Response Time	t <sub>RESPONSE</sub>	$I_{P} = I_{P}(max), T_{A} = 25^{\circ}C, C_{L} = 1 \text{ nF}$	-	4	_	μs
Bandwidth	BW	Small signal –3 dB; C <sub>L</sub> = 1 nF	-	120	_	kHz
Noise Density	I <sub>ND</sub>	Input referenced noise density; $T_A = 25^{\circ}C$ , $C_L = 1 \text{ nF}$	-	200	_	µA <sub>(rms)</sub> / √Hz
Noise	I <sub>N</sub>	Input referenced noise: $C_F = 4.7 \text{ nF}$ , $C_L = 1 \text{ nF}$ , BW = 18 kHz, $T_A = 25^{\circ}\text{C}$	_	27	_	mA <sub>(rms)</sub>
Nonlinearity	E <sub>LIN</sub>	Through full range of I <sub>P</sub>	-1.5	-	+1.5	%
Sensitivity Ratiometry Coefficient	SENS_RAT_ COEF	V <sub>cc</sub> = 3.0 to 3.6 V, T <sub>A</sub> = 25°C	_	1.3	_	_
Zero Current Output Ratiometry Coefficient	QVO_RAT_ COEF	V <sub>cc</sub> = 3.0 to 3.6 V, T <sub>A</sub> = 25°C	-	1	_	_
O - transfiller (1/2) the res 2	V <sub>OH</sub>	$R_{L} = 4.7 \text{ k}\Omega$	-	V <sub>CC</sub> – 0.3	_	V
Saturation Voltage <sup>3</sup>	V <sub>OL</sub>	R <sub>L</sub> = 4.7 kΩ	-	0.3	_	V
Power-On Time	t <sub>PO</sub>	Output reaches 90% of steady-state level, $T_A = 25^{\circ}C$ , $I_P = I_{PR}(max)$ applied	-	80	_	μs
Shorted Output to Ground Current	I <sub>sc(gnd)</sub>	T <sub>A</sub> = 25°C	-	3.3	_	mA
Shorted Output to V <sub>CC</sub> Current	I <sub>sc(vcc)</sub>	T <sub>A</sub> = 25°C	-	45	_	mA

<sup>1</sup>Device may be operated at higher primary current levels, I<sub>P</sub>, ambient temperatures, T<sub>A</sub>, and internal leadframe temperatures, provided the Maximum Junction Temperature, T<sub>J</sub>(max), is not exceeded.

 ${}^{2}R_{F(int)}$  forms an RC circuit via the FILTER pin.  ${}^{3}The sensor IC will continue to respond to current beyond the range of I<sub>P</sub> until the high or low saturation voltage; however, the nonlinearity in this region will be worse than$ through the rest of the measurement range.



#### xLLCTR-10AU PERFORMANCE CHARACTERISTICS: T<sub>A</sub> Range L, valid at T<sub>A</sub> = -40°C to 150°C, V<sub>CC</sub> = 3.3 V, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ.1	Max.	Unit
Nominal Performance						
Current Sensing Range	I <sub>PR</sub>		0	-	10	A
Sensitivity	Sens	$I_{PR(min)} < I_P < I_{PR(max)}$	-	264	_	mV/A
Zero Current Output Voltage	V <sub>IOUT(Q)</sub>	Unidirectional; I <sub>P</sub> = 0 A	-	Vcc x 0.1	_	V
Accuracy Performance						
Total Output Error <sup>2</sup>	E <sub>TOT</sub>	$I_{P} = I_{PR(max)}; T_{A} = 25^{\circ}C \text{ to } 150^{\circ}C$	-2.5	±0.9	2.5	%
		$I_{P} = I_{PR(max)}; T_{A} = -40^{\circ}C \text{ to } 25^{\circ}C$	-6	±4	6	
Total Output Error Compone	nts <sup>3</sup> E <sub>TOT</sub> = E	E <sub>SENS</sub> + 100 x V <sub>OE</sub> /(Sens x I <sub>P</sub> )				
Sonoitivity Error	E <sub>sens</sub>	$I_{P} = I_{PR(max)}; T_{A} = 25^{\circ}C \text{ to } 150^{\circ}C$	-2	±0.9	2	- %
Sensitivity Error		$I_P = I_{PR(max)}$ ; $T_A = -40^{\circ}$ C to 25°C	-5.5	±4	5.5	
Offeet \/eltere	N	I <sub>P</sub> = 0 A; T <sub>A</sub> = 25°C to 150°C	-15	±5	15	mV
Offset Voltage	V <sub>OE</sub>	$I_{P} = 0 \text{ A}; T_{A} = -40^{\circ}\text{C} \text{ to } 25^{\circ}\text{C}$	-30	±15	30	
Lifetime Drift Characteristics	i					
Sensitivity Error Lifetime Drift	E <sub>sens_drift</sub>		-	±2	_	%
Total Output Error Lifetime Drift	E <sub>tot_drift</sub>		-	±2	-	%

<sup>1</sup> Typical values with ± are 3 sigma values

 <sup>2</sup> Percentage of I<sub>P</sub>, with I<sub>P</sub> = I<sub>PR(max)</sub>.
<sup>3</sup> A single part will not have both the maximum/minimum sensitivity error and maximum/minimum offset voltage, as that would violate the maximum/minimum total output error specification. Also, 3 sigma distribution values are combined by taking the square root of the sum of the squares. See Application Information section.

#### xLLCTR-20AB PERFORMANCE CHARACTERISTICS: T<sub>A</sub> Range L, valid at T<sub>A</sub> = -40°C to 150°C, V<sub>CC</sub> = 3.3 V, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ.1	Max.	Unit
Nominal Performance			·			
Current Sensing Range	I <sub>PR</sub>		-20	-	20	A
Sensitivity	Sens	I <sub>PR(min)</sub> < I <sub>P</sub> < I <sub>PR(max)</sub>	-	66	-	mV/A
Zero Current Output Voltage	V <sub>IOUT(Q)</sub>	Bidirectional; I <sub>P</sub> = 0 A	-	Vcc x 0.5	-	V
Accuracy Performance						
Tatal Quitaut Error?	E <sub>TOT</sub>	$I_{P} = I_{PR(max)}; T_{A} = 25^{\circ}C \text{ to } 150^{\circ}C$	-2	±0.8	2	- %
Total Output Error <sup>2</sup>		$I_{P} = I_{PR(max)}; T_{A} = -40^{\circ}C \text{ to } 25^{\circ}C$	-6	±4	6	
Total Output Error Componen	nts <sup>3</sup> E <sub>TOT</sub> = E	E <sub>SENS</sub> + 100 x V <sub>OE</sub> /(Sens x I <sub>P</sub> )				
Constitute Error	E <sub>sens</sub>	$I_{P} = I_{PR(max)}; T_{A} = 25^{\circ}C \text{ to } 150^{\circ}C$	-1.5	±0.8	1.5	- %
Sensitivity Error		$I_{P} = I_{PR(max)}; T_{A} = -40^{\circ}C \text{ to } 25^{\circ}C$	-5.5	±4	5	
Offeet Veltege	M	I <sub>P</sub> = 0 A; T <sub>A</sub> = 25°C to 150°C	-10	±4	10	mV
Offset Voltage	V <sub>OE</sub>	$I_{P} = 0 \text{ A}; T_{A} = -40^{\circ}\text{C} \text{ to } 25^{\circ}\text{C}$	-30	±5	30	
Lifetime Drift Characteristics						
Sensitivity Error Lifetime Drift	E <sub>sens_drift</sub>		_	±2	-	%
Total Output Error Lifetime Drift	E <sub>tot_drift</sub>		-	±2	_	%

 $^{\rm 1}$  Typical values with  $\pm$  are 3 sigma values

<sup>2</sup> Percentage of  $I_P$ , with  $I_P = I_{PR(max)}$ 

<sup>3</sup> A single part will not have both the maximum/minimum sensitivity error and maximum/minimum offset voltage, as that would violate the maximum/minimum total output error specification. Also, 3 sigma distribution values are combined by taking the square root of the sum of the squares. See Application Information section.



#### xLLCTR-30AB PERFORMANCE CHARACTERISTICS: T<sub>A</sub> Range L, valid at T<sub>A</sub> = -40°C to 150°C, V<sub>CC</sub> = 3.3 V, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. <sup>1</sup>	Max.	Unit
Nominal Performance				•		
Current Sensing Range	I <sub>PR</sub>		-30	-	30	A
Sensitivity	Sens	$I_{PR(min)} < I_P < I_{PR(max)}$	-	44	-	mV/A
Zero Current Output Voltage	V <sub>IOUT(Q)</sub>	Bidirectional; I <sub>P</sub> = 0 A	-	Vcc x 0.5	-	V
Accuracy Performance						<u>.</u>
Tatal Quitaut Errar <sup>2</sup>	E <sub>TOT</sub>	$I_{P} = I_{PR(max)}; T_{A} = 25^{\circ}C \text{ to } 150^{\circ}C$	-2	±0.7	2	- %
Total Output Error <sup>2</sup>		$I_P = I_{PR(max)}; T_A = -40^{\circ}C \text{ to } 25^{\circ}C$	-6	±4	6	
Total Output Error Component	nts <sup>3</sup> E <sub>TOT</sub> = E	E <sub>SENS</sub> + 100 x V <sub>OE</sub> /(Sens x I <sub>P</sub> )				
Consitivity Error	E <sub>sens</sub>	$I_{P} = I_{PR(max)}; T_{A} = 25^{\circ}C \text{ to } 150^{\circ}C$	-1.5	±0.7	1.5	%
Sensitivity Error		$I_P = I_{PR(max)}$ ; $T_A = -40^{\circ}$ C to 25°C	-5.5	±4	5	
Offeret Vielbarre	N	I <sub>P</sub> = 0 A; T <sub>A</sub> = 25°C to 150°C	-10	±3	10	
Offset Voltage	V <sub>OE</sub>	$I_{P} = 0 \text{ A}; T_{A} = -40^{\circ}\text{C} \text{ to } 25^{\circ}\text{C}$	-30	±5	30	mV
Lifetime Drift Characteristics						
Sensitivity Error Lifetime Drift	E <sub>sens_drift</sub>		_	±2	_	%
Total Output Error Lifetime Drift	E <sub>tot_drift</sub>		-	±2	_	%

<sup>1</sup> Typical values with ± are 3 sigma values

<sup>2</sup> Percentage of I<sub>p</sub>, with I<sub>p</sub> = I<sub>pR(max)</sub>. <sup>3</sup> A single part will not have both the maximum/minimum sensitivity error and maximum/minimum offset voltage, as that would violate the maximum/minimum total output error specification. Also, 3 sigma distribution values are combined by taking the square root of the sum of the squares. See Application Information section.

#### xLLCTR-40AB PERFORMANCE CHARACTERISTICS: $T_A$ Range L, valid at $T_A = -40^{\circ}$ C to 150°C, $V_{CC} = 3.3$ V, unless otherwise specified

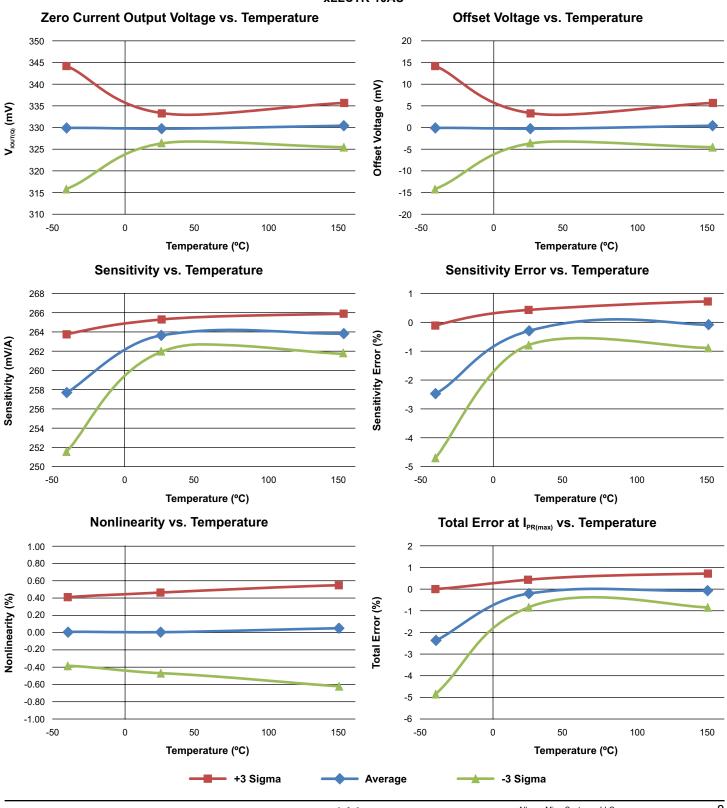
Characteristic	Symbol	Test Conditions	Min.	Typ.1	Max.	Unit
Nominal Performance						
Current Sensing Range	I <sub>PR</sub>		-40	-	40	A
Sensitivity	Sens	$I_{PR(min)} < I_P < I_{PR(max)}$	-	33	-	mV/A
Zero Current Output Voltage	V <sub>IOUT(Q)</sub>	Bidirectional; I <sub>P</sub> = 0 A	-	Vcc x 0.5	-	V
Accuracy Performance						
Total Output Error <sup>2</sup>	E <sub>TOT</sub>	$I_{P} = I_{PR(max)}; T_{A} = 25^{\circ}C \text{ to } 150^{\circ}C$	-2	±1	2	- %
Total Output Error <sup>2</sup>		$I_{P} = I_{PR(max)}; T_{A} = -40^{\circ}C \text{ to } 25^{\circ}C$	-6	±4	6	
Total Output Error Component	nts <sup>3</sup> E <sub>TOT</sub> = E	E <sub>SENS</sub> + 100 x V <sub>OE</sub> /(Sens x I <sub>P</sub> )				
Sonoitivity Error	E <sub>sens</sub>	$I_{P} = I_{PR(max)}; T_{A} = 25^{\circ}C \text{ to } 150^{\circ}C$	-1.5	±1	1.5	- %
Sensitivity Error		$I_P = I_{PR(max)}$ ; $T_A = -40^{\circ}C$ to 25°C	-5.5	±4	5	
Offset Voltage	V	I <sub>P</sub> = 0 A; T <sub>A</sub> = 25°C to 150°C	-10	±3	10	m∨
Oliset voltage	V <sub>OE</sub>	$I_{P} = 0 \text{ A}; T_{A} = -40^{\circ}\text{C} \text{ to } 25^{\circ}\text{C}$	-30	±5	30	
Lifetime Drift Characteristics						
Sensitivity Error Lifetime Drift	E <sub>sens_drift</sub>		-	±2	_	%
Total Output Error Lifetime Drift	E <sub>tot_drift</sub>		-	±2	_	%

<sup>1</sup> Typical values with  $\pm$  are 3 sigma values

<sup>2</sup> Percentage of  $I_P$ , with  $I_P = I_{PR(max)}$ .

<sup>3</sup> A single part will not have both the maximum/minimum sensitivity error and maximum/minimum offset voltage, as that would violate the maximum/minimum total output error specification. Also, 3 sigma distribution values are combined by taking the square root of the sum of the squares. See Application Information section.





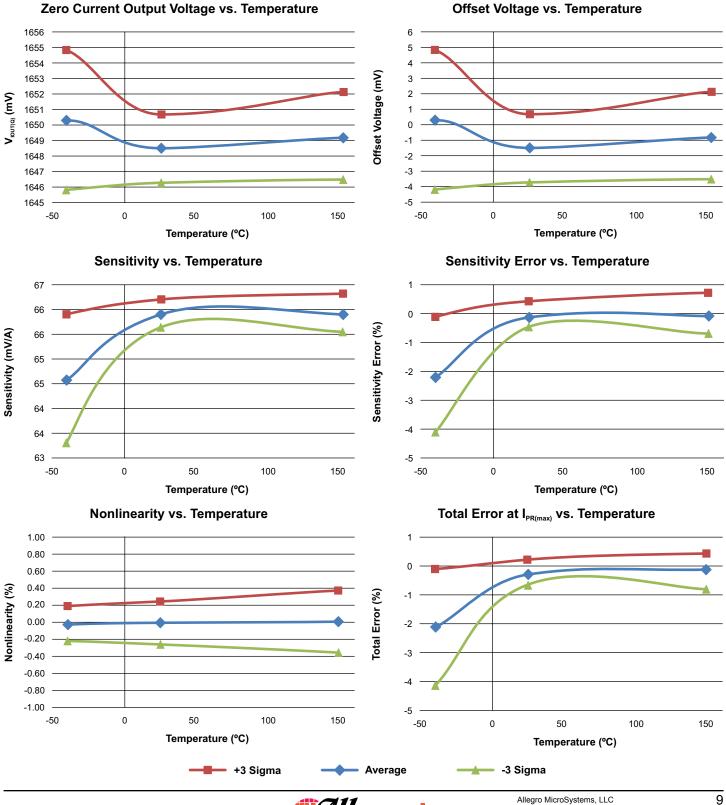
#### CHARACTERISTIC PERFORMANCE xLLCTR-10AU

Allegro<sup>M</sup>

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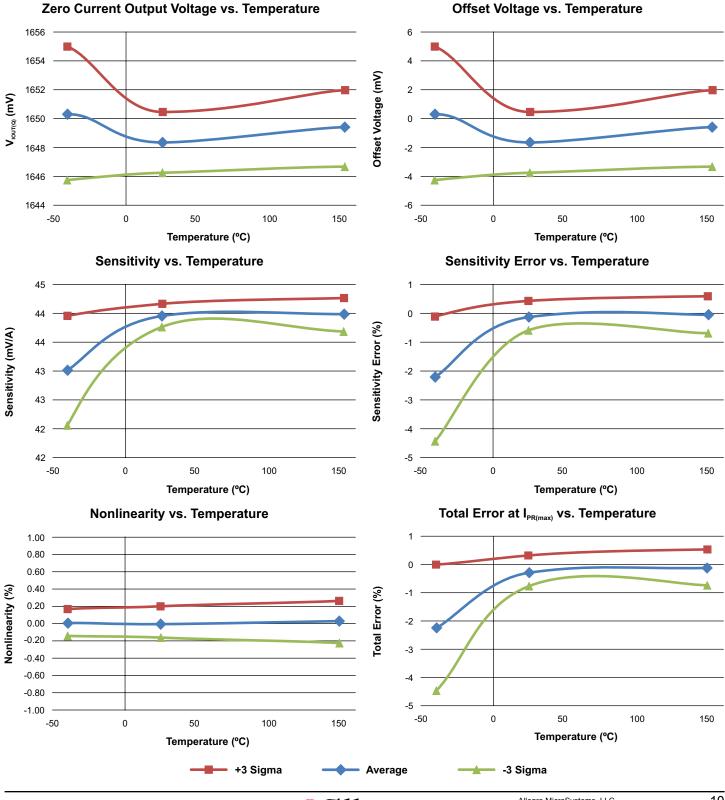
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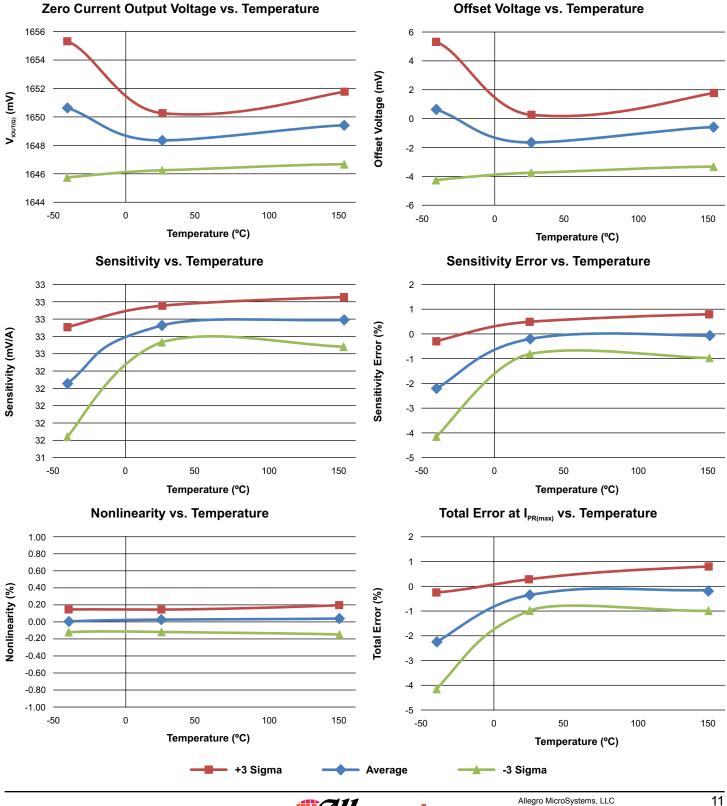
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#### xLLCTR-40AB





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## **APPLICATION INFORMATION**

## **Estimating Total Error vs. Sensed Current**

The Performance Characteristics tables give distribution (±3 sigma) values for Total Error at  $I_{PR(max)}$ ; however, one often wants to know what error to expect at a particular current. This can be estimated by using the distribution data for the components of Total Error, Sensitivity Error and Offset Voltage. The ±3 sigma value for Total Error ( $E_{TOT}$ ) as a function of the sensed current ( $I_P$ ) is estimated as:

$$E_{TOT}(I_p) = \sqrt{E_{SENS}^2 + \left(\frac{100 \times V_{OE}}{Sens \times I_p}\right)^2}$$

Here,  $E_{SENS}$  and  $V_{OE}$  are the ±3 sigma values for those error terms. If there is an average sensitivity error or average offset voltage, then the average Total Error is estimated as:

$$E_{TOT_{AVG}}(I_{P}) = E_{SENS_{AVG}} + \frac{100 \times V_{OE_{AVG}}}{Sens \times I_{P}}$$

The resulting total error will be a sum of  $E_{TOT}$  and  $E_{TOT\_AVG}$ . Using these equations and the 3 sigma distributions for Sensitivity Error and Offset Voltage, the Total Error vs. sensed current (I<sub>p</sub>) is below for the ACS725LLCTR-20AB. As expected, as one goes towards zero current, the error in percent goes towards infinity due to division by zero.

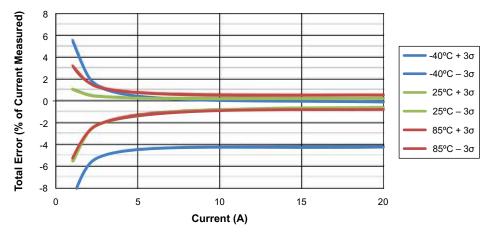


Figure 1: Predicted Total Error as a Function of the Sensed Current for the ACS725LLCTR-20AB



## DEFINITIONS OF ACCURACY CHARACTERISTICS

**Sensitivity (Sens).** The change in sensor IC output in response to a 1 A change through the primary conductor. The sensitivity is the product of the magnetic circuit sensitivity (G/A) (1 G = 0.1 mT) and the linear IC amplifier gain (mV/G). The linear IC amplifier gain is programmed at the factory to optimize the sensitivity (mV/A) for the full-scale current of the device.

**Nonlinearity** ( $E_{LIN}$ ). The nonlinearity is a measure of how linear the output of the sensor IC is over the full current measurement range. The nonlinearity is calculated as:

$$E_{LIN} = \left\{ 1 - \left[ \frac{V_{IOUT}(I_{PR(max)}) - V_{IOUT(Q)}}{2 \cdot V_{IOUT}(I_{PR(max)}/2) - V_{IOUT(Q)}} \right] \right\} \cdot 100(\%)$$

where  $V_{IOUT}(I_{PR}(max))$  is the output of the sensor IC with the maximum measurement current flowing through it and  $V_{IOUT}(I_{PR}(max)/2)$  is the output of the sensor IC with half of the maximum measurement current flowing through it.

**Zero Current Output Voltage (V**<sub>IOUT(Q)</sub>). The output of the sensor when the primary current is zero. For a unipolar supply voltage, it nominally remains at  $0.5 \times V_{CC}$  for a bidirectional device and  $0.1 \times V_{CC}$  for a unidirectional device. For example, in the case of a bidirectional output device,  $V_{CC} = 3.3$  V translates into  $V_{IOUT(Q)} = 1.65$  V. Variation in  $V_{IOUT(Q)}$  can be attributed to the resolution of the Allegro linear IC quiescent voltage trim and thermal drift.

**Offset Voltage (V**<sub>OE</sub>). The deviation of the device output from its ideal quiescent value of  $0.5 \times V_{CC}$  (bidirectional) or  $0.1 \times V_{CC}$ (unidirectional) due to nonmagnetic causes. To convert this voltage to amperes, divide by the device sensitivity, Sens.

**Total Output Error (E**<sub>TOT</sub>). The difference between the current measurement from the sensor IC and the actual current ( $I_p$ ), relative to the actual current. This is equivalent to the difference between the ideal output voltage and the actual output voltage, divided by the ideal sensitivity, relative to the current flowing through the primary conduction path:

$$E_{TOT}(I_p) = \frac{V_{IOUT\_ideal}(I_p) - V_{IOUT}(I_p)}{Sens_{ideal}(I_p) \bullet I_p} \bullet 100 \ (\%)$$

The Total Output Error incorporates all sources of error and is a function of I<sub>P</sub>. At relatively high currents,  $E_{TOT}$  will be mostly due to sensitivity error, and at relatively low currents,  $E_{TOT}$  will be mostly due to Offset Voltage (V<sub>OE</sub>). In fact, at I<sub>P</sub> = 0,  $E_{TOT}$  approaches infinity due to the offset. This is illustrated in Figures 1 and 2. Figure 1 shows a distribution of output voltages versus I<sub>P</sub> at 25°C and across temperature. Figure 2 shows the corresponding  $E_{TOT}$  versus I<sub>P</sub>.

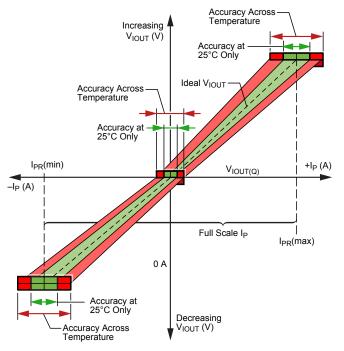


Figure 1: Output Voltage versus Sensed Current

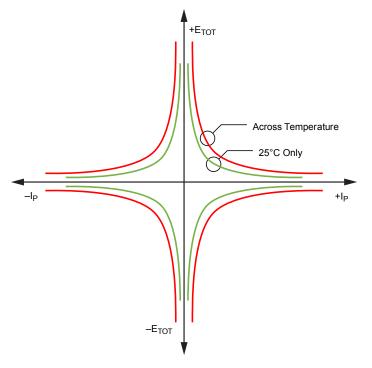


Figure 2: Total Output Error versus Sensed Current



Sensitivity Ratiometry Coefficient (SENS\_RAT\_COEF). The coefficient defining how the sensitivity scales with  $V_{CC}$ . The ideal coefficient is 1, meaning the sensitivity scales proportionally with  $V_{CC}$ . A 10% increase in  $V_{CC}$  results in a 10% increase in sensitivity. A coefficient of 1.1 means that the sensitivity increases by 10% more than the ideal proportionality case. This means that a 10% increase in Vcc results in an 11% increase in sensitivity. This relationship is described by the following equation:

$$Sens(V_{cc}) = Sens(3.3 V) \left[ 1 + \frac{(V_{cc} - 3.3 V) \cdot SENS_RAT_COEF}{3.3 V} \right]$$

This can be rearranged to define the sensitivity ratiometry coefficient as:

$$SENS\_RAT\_COEF = \left[\frac{Sens(V_{cc})}{Sens(3.3 V)} - 1\right] \bullet \frac{3.3 V}{(V_{cc} - 3.3 V)}$$

#### Zero Current Output Ratiometry Coefficient (QVO\_RAT\_

**COEF).** The coefficient defining how the zero current output voltage scales with  $V_{CC}$ . The ideal coefficient is 1, meaning the output voltage scales proportionally with  $V_{CC}$ , always being equal to  $V_{CC}/2$ . A coefficient of 1.1 means that the zero current output voltage increases by 10% more than the ideal proportionality case. This means that a 10% increase in Vcc results in an 11% increase in the zero current output voltage. This relationship is described by the following equation:

$$VIOUTQ(V_{cc}) = VIOUTQ(3.3 V) \left[ 1 + \frac{(V_{cc} - 3.3 V) \cdot QVO_RAT_COEF}{3.3 V} \right]$$

This can be rearranged to define the zero current output ratiometry coefficient as:

$$QVO\_RAT\_COEF = \left[\frac{VIOUTQ(V_{cc})}{VIOUTQ(3.3 V)} - 1\right] \bullet \frac{3.3 V}{(V_{cc} - 3.3 V)}$$



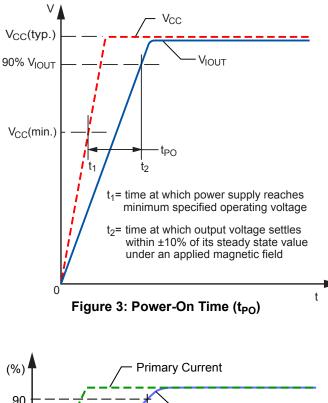
## DEFINITIONS OF DYNAMIC RESPONSE CHARACTERISTICS

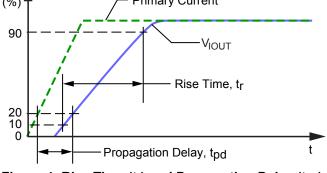
**Power-On Time (t**<sub>PO</sub>). When the supply is ramped to its operating voltage, the device requires a finite time to power its internal components before responding to an input magnetic field. Power-On Time,  $t_{PO}$ , is defined as the time it takes for the output voltage to settle within ±10% of its steady state value under an applied magnetic field, after the power supply has reached its minimum specified operating voltage,  $V_{CC}(min)$ , as shown in the chart at right.

**Rise Time (t<sub>r</sub>).** The time interval between a) when the sensor IC reaches 10% of its full scale value, and b) when it reaches 90% of its full scale value. The rise time to a step response is used to derive the bandwidth of the current sensor IC, in which  $f(-3 \text{ dB}) = 0.35/t_r$ . Both  $t_r$  and  $t_{\text{RESPONSE}}$  are detrimentally affected by eddy current losses observed in the conductive IC ground plane.

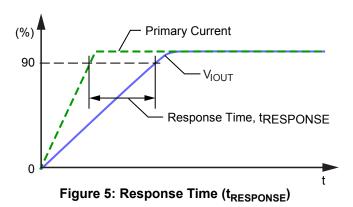
**Propagation Delay**  $(t_{pd})$ . The propagation delay is measured as the time interval a) when the primary current signal reaches 20% of its final value, and b) when the device reaches 20% of its output corresponding to the applied current.

**Response Time (t<sub>RESPONSE</sub>).** The time interval between a) when the primary current signal reaches 90% of its final value, and b) when the device reaches 90% of its output corresponding to the applied current.











## PACKAGE OUTLING DRAWING

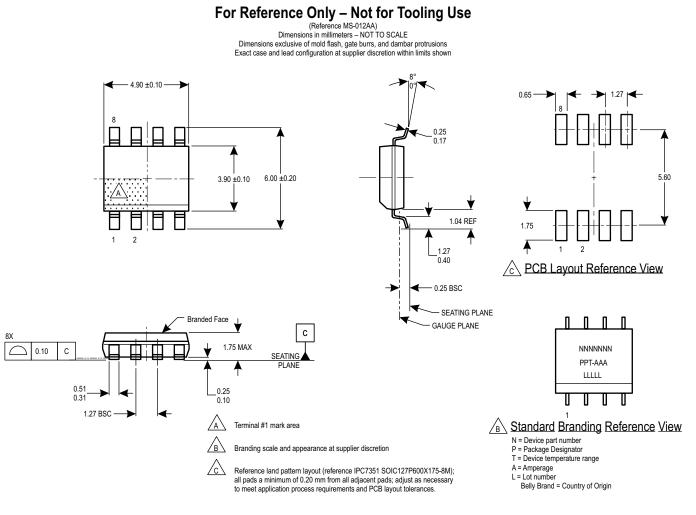


Figure 6: Package LC, 8-pin SOICN



#### **Document Revision History**

Revision	Change	Pages	Responsible	Date
0	Added Charecteristic Performance graphs and Application Information to Preliminary draft to create Final draft	All	A. Latham	January 19, 2015

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